Keylock Switch S40/S60



Keylock switch with multiple locking functions.

- Cylinder locks with 5 tumblers.
- Positions in which the key cannot be retained are freely selectable.
- Up to 200 different locks possible.
- Gold contacts on request.
- Impulse contact for first or last switching position (spring return).
- Type S 40: Max. 4 levels per switch for free wiring.
- Type S 60: with one level alternatively for printed circuits or free wiring.
- Locking versions:
- Identical key codes, A.
- Different key codes (max. 200), B.
- Master key system: Up to 15 different locks can be operated with one main key, C.
- Pass key system: Up to 9 keys in max. 3 groups. Main key for all keys, pass keys for up to 3 locks per group, D.
- Up to 4 different priority status keys, E.
- Central locking key system: Up to 9 different key lock switches and one central key lock switch, which can be operated with all keys, F.
- Different keys to switch clockwise or anti-clockwise from a neutral position, G.

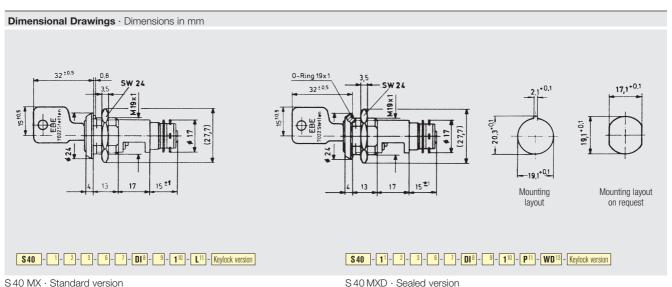
1.0 Construction		
1.1 Number of wafers max.		4 wafers
Design B, dete	binations per wafer ent angle 60	1x6 to 1x2; 2x3 to 2x2; 3x2; 4x2
Design E, detent angle 30°		1x12 to 1x2; 2x6 to 2x2; 3x4 to 3x2; 4x3 to 4x2
1.3 Contacts		Soldering lugs, Single-wafer switch also with pins (S60)
1.4 Mounting		Central front-mounting. Upon request back mounting with front ring which can be screwed on
2.0 Electrical Data		Ag-version
2.1 Switching power max.		10 VA/W
2.2 Switching voltage max.		115 V-
2.3 Switching current max.		0,5 A
2.4 Rest current max. at ∂u 20°C		2 A
2.5 Test voltage at 50 Hz	between contacts	900 V
	contact/ground	1000 V
	keylock/switch	10 kV
2.6 Life expectance	y without electrical load	≥ 25 000 cycles
2.7 Contact resistance initial value		<20 mΩ
2.8 Insulation resistance		1×10 ¹¹ Ω
3.0 Mechanical D	Data	
3.1 Switching mode		Shorting or non-shorting
3.2 Stops		Fixed or without stop
3.3 Operating torque according to design		≥6 Ncm
3.4 Stop strength		≥ 70 Ncm
3.5 Fastening torque max		≥ 200 Ncm
3.6 Dust protection		Sealed wafers
3.7 Waterproofing		Special version watertight against front panel or internally against the switch
4.0 Other Data		
4.1 Contact material		Ag; Au on request
4.2 Insulating material Wafer		Diallylphthalate, DAP; Code DI
	Rotor	Noryl, PPO; Code NO
4.3 Soldering time and temperature max.		5s at 260°C
		3s at 350°C, manual soldering
Ordering codes		
with one main D = Pass key syste Main key for al		codes
		codes (max. 200)
		stem: Up to 15 different locks can be operated key
		em: Up to 9 keys in max. 3 groups. Ill keys, pass keys for up to three locks per group.
		ent priority status keys.
	F = Central locking	g key system: Up to 9 different key lock switches ral keylock switch, which can be operated with all keys
		to switch clockwise or anti-clockwise
		position

from a neutral position

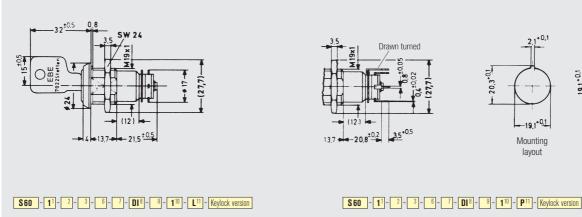


we create solutions

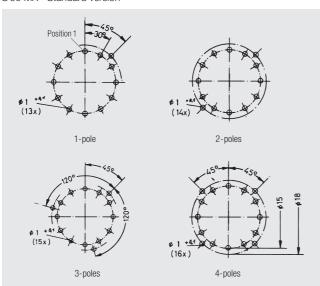
The bold-typed data in the yellow order blocks remain unchanged. Normal-typed data match the drawings and can be modified according to your wishes. Blanks need to be completed according to the ordering details on the previous page and the inside front cover.



S 40 MX · Standard version

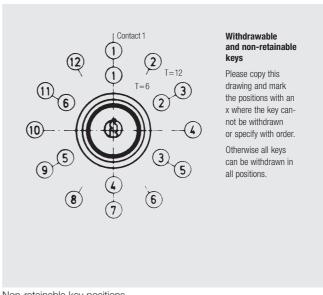


S 60 MX · Standard version



Drill scheme for wafers - view from mounting side

S 60 EMX · Soldering pin version



Non-retainable key positions

Mounting layout

on request